

## Features:

- ◇ Uniform light output.
- ◇ Low power consumption.
- ◇ I.C. Compatible.
- ◇ Long life-solid state reliability.
- ◇ The product itself will remain within RoHS compliant Version.

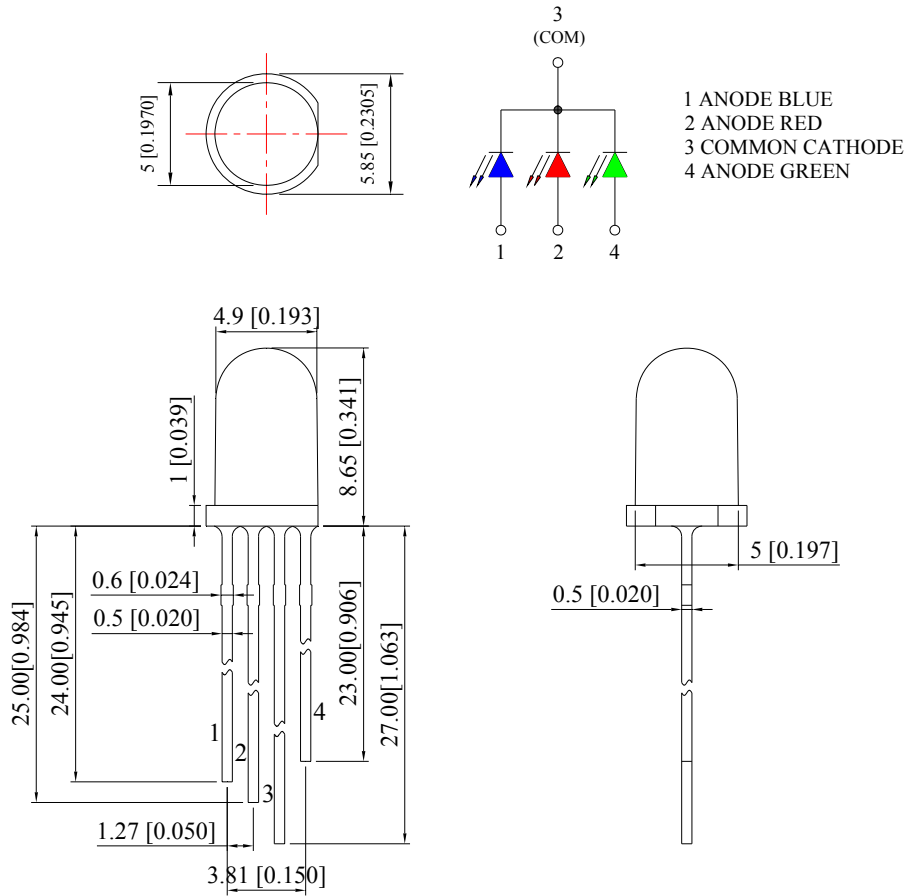
## Descriptions:

- ◇ The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- ◇ The Pure Green source color devices are made with InGaN on Sapphire substrate Light Emitting Diode.
- ◇ The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode.

## Applications:

- ◇ TV set.
- ◇ Monitor.
- ◇ Telephone.
- ◇ Computer.
- ◇ Circuit board, etc.

## Package Dimension:



Part No.	Chip Material	Lens Color	Source Color
5-22-WC-RPGBC-CC	AlGaInP	Water Clear	Hyper Red
	InGaN		Pure Green
	InGaN		Blue

### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25\text{mm}$  (.010") unless otherwise noted.
3. Protruded resin under flange is 1.00mm (.039") max.
4. Specifications are subject to change without notice.

### Absolute Maximum Ratings at Ta=25°C

Parameters		Symbol	Max.	Unit
Power Dissipation	Hyper Red	PD	65	mW
	Pure Green		95	
	Blue		95	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)		IFP	100	mA
Ultra Red Chip Forward Current		IF	25	mA
Pure Green Chip Forward Current		IF	25	mA
Blue Chip Continuous Forward Current		IF	25	mA
Reverse Voltage		VR	5	V
Operating Temperature Range		Topr	-40°C to +85°C	
Storage Temperature Range		Tstg	-40°C to +100°C	
Lead Soldering Temperature [4mm (.157") From Body]		Tsld	260°C for 5 Seconds	

### Electrical Optical Characteristics at Ta=25°C

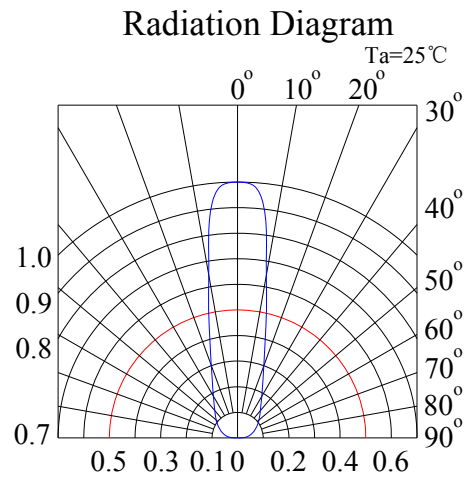
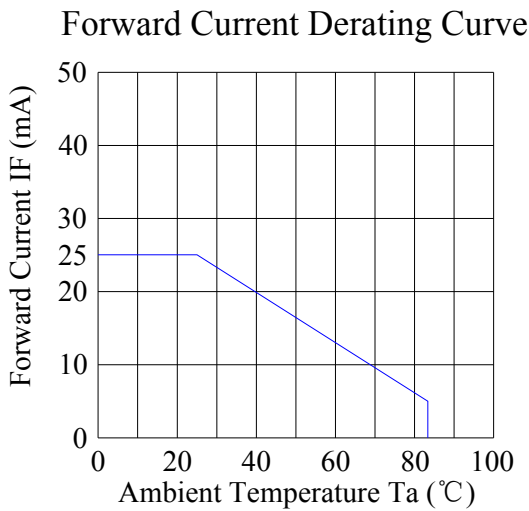
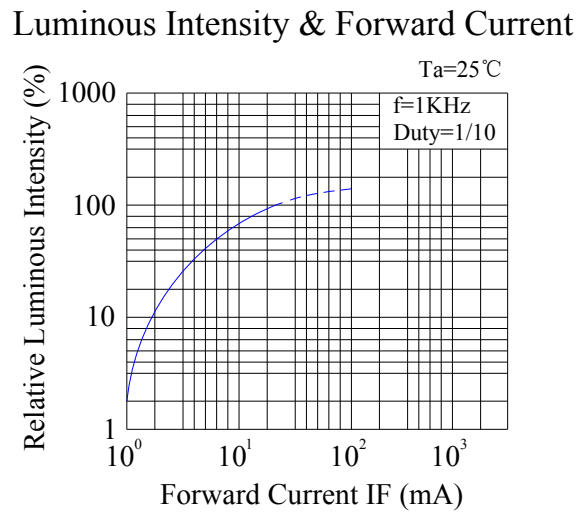
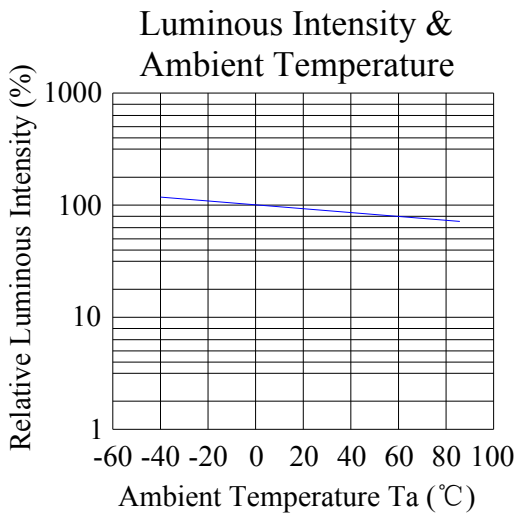
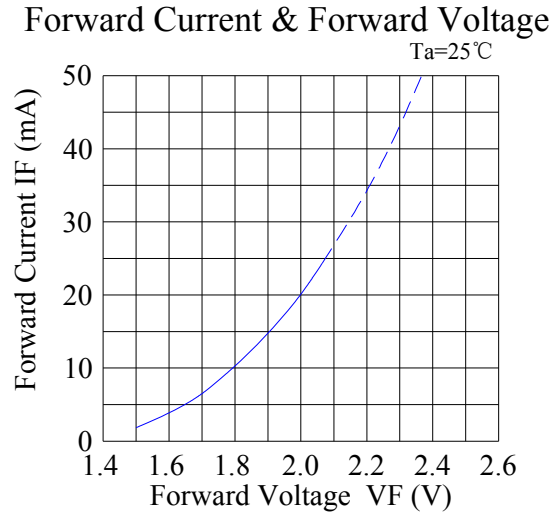
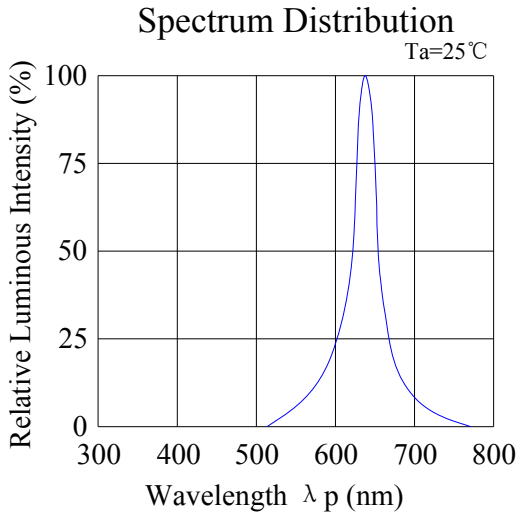
Parameters	Symbol	Emitting Color	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity *	IV	Hyper Red	1600	3200	---	mcd	IF=20mA (Note 1)
		Pure Green	2000	4000	---		
		Blue	1000	2000	---		
Viewing Angle *	2θ <sub>1/2</sub>	Hyper Red	---	25	---	Deg	IF=20mA (Note 2)
		Pure Green	---	25	---		
		Blue	---	25	---		
Peak Emission Wavelength	λ <sub>p</sub>	Hyper Red	---	632	---	nm	IF=20mA
		Pure Green	---	520	---		
		Blue	---	468	---		
Dominant Wavelength	λ <sub>d</sub>	Hyper Red	---	624	---	nm	IF=20mA (Note 3)
		Pure Green	---	525	---		
		Blue	---	470	---		
Forward Voltage	VF	Hyper Red	1.60	2.00	2.60	V	IF=20mA
		Pure Green	2.80	3.20	3.80		
		Blue	2.80	3.20	3.80		
Reverse Current	IR	Hyper Red	---	---	10	μA	V <sub>R</sub> =5V
		Pure Green	---	---	10		
		Blue	---	---	10		

#### Notes:

1. Luminous Intensity Measurement allowance is ± 10%.
2. θ<sub>1/2</sub> is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength (λ<sub>d</sub>) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

## Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)

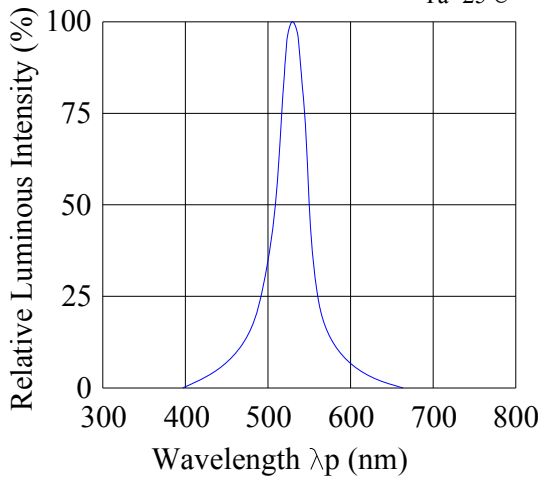
Hyper Red:



Pure Green:

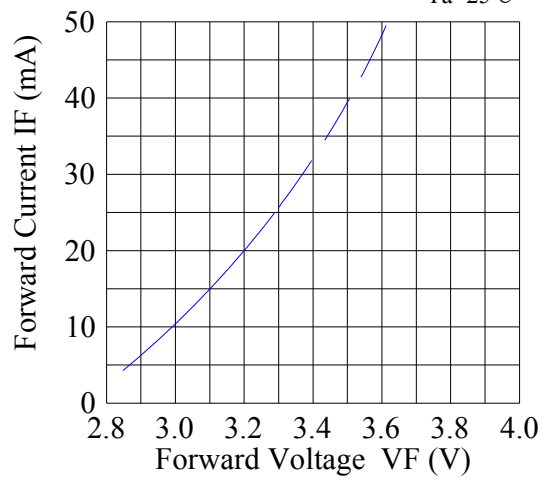
Spectrum Distribution

Ta=25°C

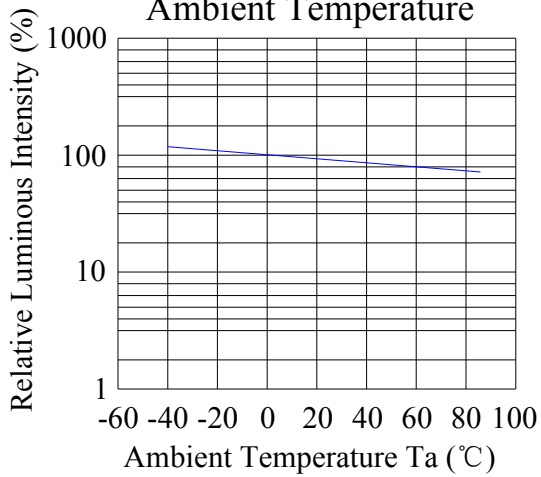


Forward Current & Forward Voltage

Ta=25°C

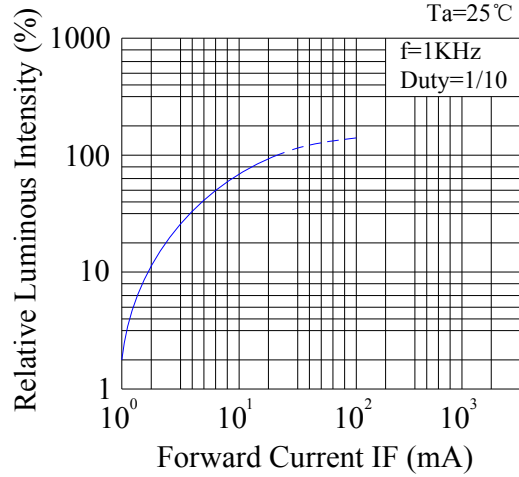


Luminous Intensity & Ambient Temperature

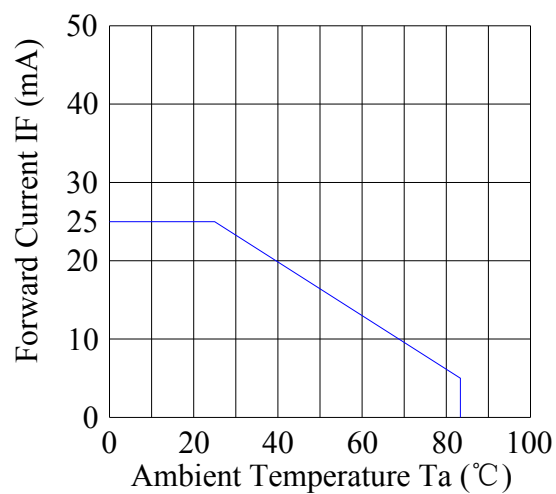


Luminous Intensity & Forward Current

Ta=25°C

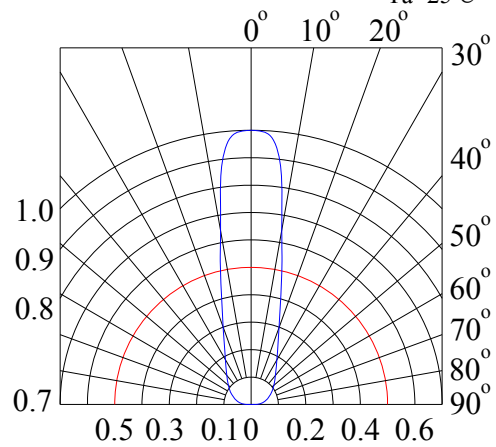


Forward Current Derating Curve



Radiation Diagram

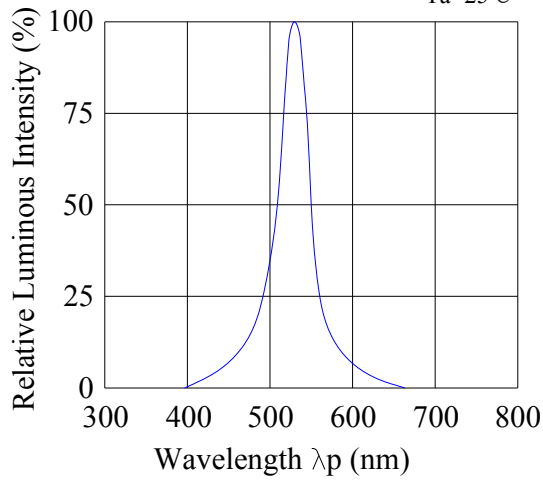
Ta=25°C



Pure Green:

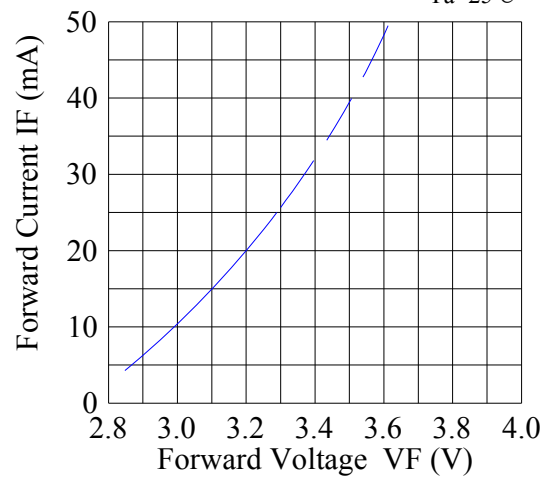
Spectrum Distribution

Ta=25°C

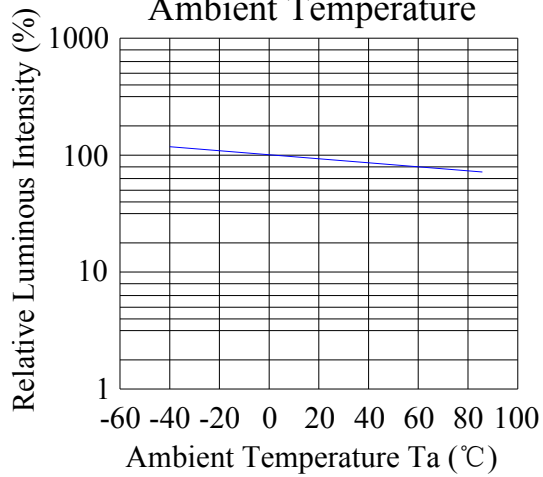


Forward Current & Forward Voltage

Ta=25°C

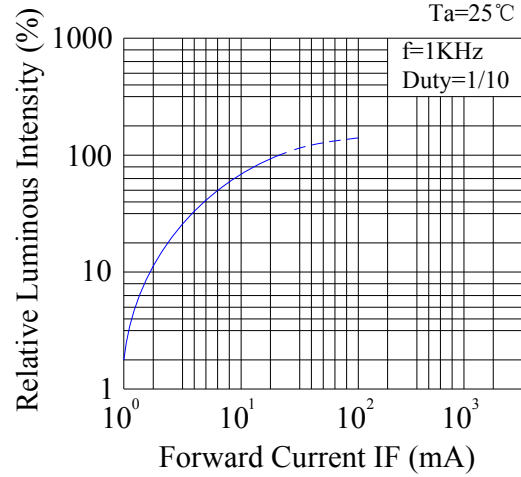


Luminous Intensity & Ambient Temperature

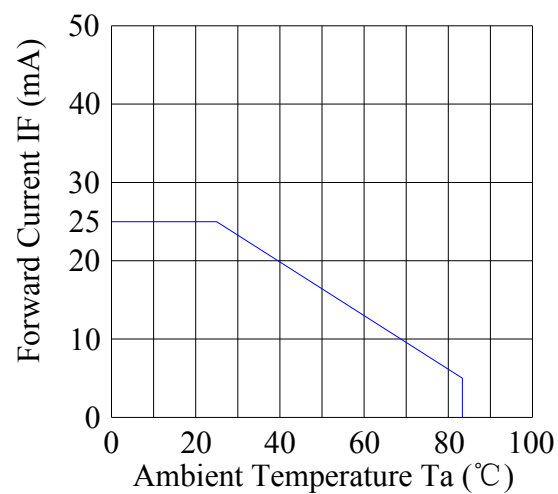


Luminous Intensity & Forward Current

Ta=25°C

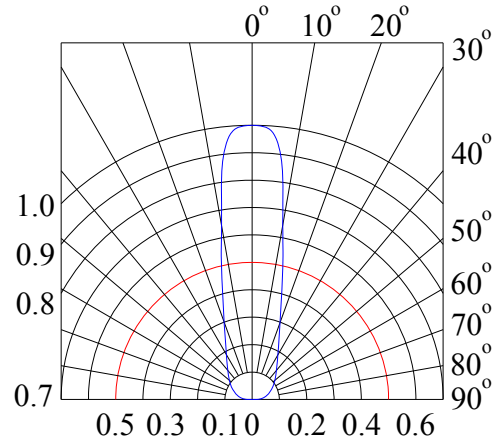


Forward Current Derating Curve



Radiation Diagram

Ta=25°C



## Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

### 1) Test Items and Results:

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat	JEITA ED-4701 300 302	Tsld=260±5°C, 10sec 3mm from the base of the epoxy bulb	1 time	0/100
Solder ability	JEITA ED-4701 300 303	Tsld=235±5°C, 5sec (using flux)	1time over 95%	0/100
Thermal Shock	JEITA ED-4701 300 307	0°C~100°C 15sec, 15sec	100 cycles	0/100
Temperature Cycle	JEITA ED-4701 100 105	-40°C~25°C~100°C~25°C 30min,5min,30min,5min	100 cycles	0/100
Moisture Resistance Cycle	JEITA ED-4701 200 203	25°C~65°C~-10°C 90%RH 24hrs/1cycle	10 cycles	0/100
High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	1000hrs	0/100
Terminal Strength (Pull test)	JEITA ED-4701 400 401	Load 10N (1kgf) 10±1sec	No noticeable damage	0/100
Terminal Strength (bending test)	JEITA ED-4701 400 401	Load 5N (0.5kgf) 0°~90°~0° bend 2 times	No noticeable damage	0/100
Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=60°C, RH=90%	1000hrs	0/100
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	1000hrs	0/100
Steady State Operating Life		Ta=25°C, IF=30mA	1000hrs	0/100
Steady State Operating Life of High Humidity Heat		Ta=60°C, RH=90%, IF=30mA	500hrs	0/100
Steady State Operating Life of Low Temperature		Ta=-30°C, IF=20mA	1000hrs	0/100

### 2) Criteria for Judging the Damage:

Item	Symbol	Test Conditions	Criteria for Judgment	
			Min	Max
Forward Voltage	VF	IF=20mA	---	F.V.*)×1.1
Reverse Current	IR	VR=5V	---	F.V.*)×2.0
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7	---

\*) F.V.: First Value.



## Please read the following notes before using the product:

### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 80%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

### 3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 4. Soldering

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Wave Soldering	
Temperature	300°C Max.	Pre-heat	100°C Max.
Soldering Time	3 sec. Max. (one time only)	Pre-heat Time	60 sec. Max.
		Solder Wave	260°C Max.
		Soldering Time	5 sec. Max.

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

### 6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.